# 2.5V Drive Pch MOS FET RTF011P02

#### Structure

Silicon P-channel MOS FET

#### ● Features

- 1) Low On-resistance.
- 2) High speed switching.

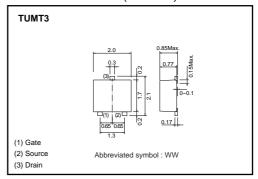
### Applications

Switching

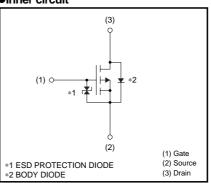
# Packaging specifications

	Package	Taping	
Type	Code	TL	
	Basic ordering unit (pieces)	3000	
RTF011P02	0		

# ●External dimensions (Unit : mm)



# ●Inner circuit



# ● Absolute maximum ratings (Ta=25°C)

Parameter		Symbol	Limits	Unit	
Drain-source voltage		V <sub>DSS</sub>	-20	V	
Gate-source voltage		V <sub>GSS</sub>	±12	V	
Drain current	Continuous	I <sub>D</sub>	±1	А	
Drain current	Pulsed	I <sub>DP</sub> *1	±4	Α	
Source current	Continuous	Is	-0.4	Α	
(Body diode)	Pulsed	I <sub>SP</sub> *1	-4	Α	
Total power dissipation		P <sub>D</sub> *2	0.8	W	
Channel temperature		Tch	150	°C	
Range of storage temperature		Tstg	-55 to +150	°C	

<sup>\*1</sup> Pw≤10μs, Duty cycle≤1% \*2 Mounted on a ceramic board

#### Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to ambient	Rth(ch-a)*	156	°C/W

<sup>\*</sup> Mounted on a ceramic board

# ●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	-	_	±10	μΑ	Vgs= ±12V, Vps=0V
Drain-source breakdown voltage	V <sub>(BR) DSS</sub>	-20	_	_	V	I <sub>D</sub> = -1mA, V <sub>GS</sub> =0V
Zero gate voltage drain current	IDSS	-	_	-1	μΑ	V <sub>DS</sub> = -20V, V <sub>GS</sub> =0V
Gate threshold voltage	V <sub>GS (th)</sub>	-0.7	_	-2.0	V	$V_{DS}$ = -10V, $I_{D}$ = -1mA
Static drain-source on-state resistance		_	280	390	mΩ	I <sub>D</sub> = -1A, V <sub>G</sub> S= -4.5V
	R <sub>DS (on)</sub> *	_	310	430	mΩ	I <sub>D</sub> = -1A, V <sub>G</sub> S= -4V
		_	570	800	mΩ	I <sub>D</sub> = -0.5A, V <sub>G</sub> S= -2.5V
Forward transfer admittance	Y <sub>fs</sub>   *	0.7	_	_	S	$V_{DS} = -10V, I_{D} = -0.5A$
Input capacitance	Ciss	_	160	_	pF	V <sub>DS</sub> = -10V
Output capacitance	Coss	_	35	_	pF	Vgs=0V
Reverse transfer capacitance	Crss	_	20	_	pF	f=1MHz
Turn-on delay time	t <sub>d (on)</sub> *	-	12	_	ns	V <sub>DD</sub> ≒ –15V
Rise time	tr *	_	11	_	ns	ID= -0.5A
Turn-off delay time	t <sub>d (off)</sub> *	_	22	_	ns	V <sub>GS</sub> = -4.5V R <sub>L</sub> =30Ω
Fall time	t <sub>f</sub> *	-	7	_	ns	R <sub>G</sub> =10Ω
Total gate charge	Qg *	-	2.0	-	nC	V <sub>DD</sub> ≒-15V V <sub>GS</sub> =-4.5V
Gate-source charge	Q <sub>gs</sub> *	_	0.6	_	nC	I <sub>D</sub> = -1A
Gate-drain charge	Q <sub>gd</sub> *	_	0.5	_	nC	$R_L=15\Omega$ $R_G=10\Omega$

\*Pulsed

# ●Body diode characteristics (Source-drain) (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	Vsp	-	_	-1.2	V	I <sub>S</sub> = -0.4A, V <sub>GS</sub> =0V

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